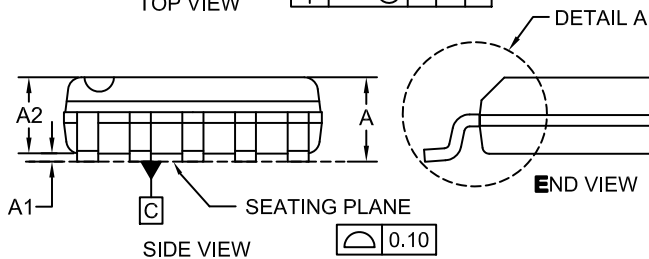
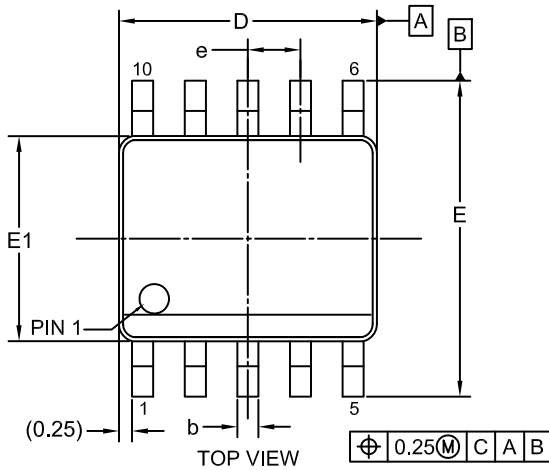
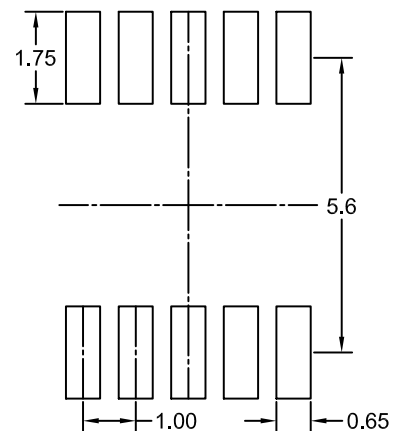
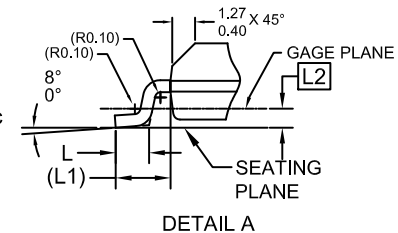

**SOIC10, 4.9x6.0, 1.0P**  
**CASE 751EE**  
**ISSUE A**

DATE 28 MAY 2019



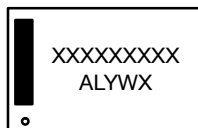
DIM	MIN.	NOM.	MAX.
A	1.35	1.55	1.75
A1	0.10	0.15	0.25
A2	1.25	1.40	1.50
b	0.30	0.40	0.45
c	0.10	0.20	0.25
D	4.80	4.90	5.00
E	5.90	6.00	6.10
E1	3.80	3.90	4.00
e	1.00 BSC		
L	0.40	0.65	1.27
L1	1.04 Reference only		
L2	0.36 BSC		


**RECOMMENDED LAND PATTERN\***

\*FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

**NOTES:**

- THIS PACKAGE DOES NOT FULLY CONFORM TO JEDEC REGISTRATION, MS-012.
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- LAND PATTERN STANDARD : SOIC127P600X175.10M

**GENERIC MARKING DIAGRAM\***


XXXX = Specific Device Code  
A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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<b>DESCRIPTION:</b>	<b>SOIC10, 4.9x6.0, 1.0P</b>	<b>PAGE 1 OF 1</b>

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